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APPLICANT : TOAGOSEI CO LTD;

INVENTOR : OKAZAKI EIICHI;

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TITLE : CURABLE RESIN COMPOSITION

ABSTRACT : PROBLEM TO BE SOLVED: To provide a curable resin composition of which the cured product obtained even with a low activity energy beam dose is excellent in a lubricating property, a releasing property, water repellency, heat resistance and an adhesion property.

SOLUTION: This curable resin composition consists of a copolymer having silicone group, maleimide group and an ethylenically unsaturated group.

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